

Features

128Kx8 bits Monolithic CMOS Static

Random Access Memory

- Access Times: 70, 85 and 100ns
- Available with Single (EDI88128) or Dual (EDI88130) Chip Selects
- Battery Back-up Operation
2V Data Retention (LP Versions)
- \bar{E} & \bar{G} Functions for Bus Control
- Inputs and Outputs Directly TTL Compatible
- Fully Static, No Clocks

Three Ceramic Package Options, JEDEC Pinout

- 32 Pin Ceramic DIP, 0.6 mils wide, No. 9
- 32 Pin Ceramic ZIP, No. 100
- 32 Lead Ceramic CSOJ, No. 141

Single +5V ($\pm 10\%$) Supply Operation

128Kx8 Monolithic CMOS Static RAM, High Speed

The EDI88128C is a high speed, high performance, monolithic Static RAM organized as 128Kx8 bits.

The device is also available as EDI88130C with an additional chip select line (S) which will automatically power down the device when proper logic levels are applied.

The second chip select (S) line can be used to provide system memory security during power down in non-battery backed up systems and simplify decoding schemes in memory banking where large multiple pages of memory are required.

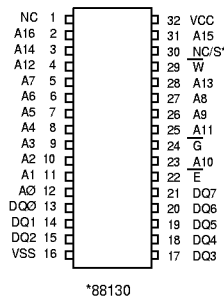
Low power versions, EDI88128LP and EDI88130LP, offer a 2V data retention function for battery back-up applications.

The EDI88128C and the EDI88130C have eight bi-directional input-output lines to provide simultaneous access to all bits in a word.

An automatic power down feature permits the on-chip circuitry to enter a very low standby power mode and be brought back into operation at a speed equal to the address access time.

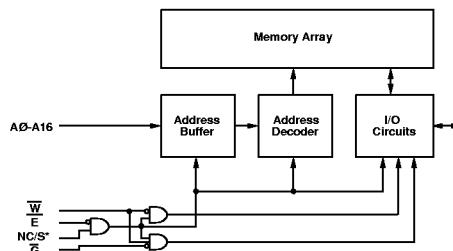
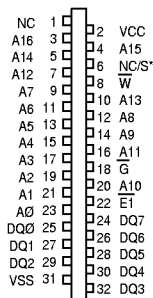
Military product is available compliant to Appendix A of Mil-PRF-38535.

Pin Configurations and Block Diagram



Pin Names

A0-A16	Address Inputs
E	Chip Enable
S	Chip Select
W	Write Enable
G	Output Enable
DQ0-DQ7	Data Input/Output
VCC	Power (+5V $\pm 10\%$)
VSS	Ground
NC	No Connection



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Absolute Maximum Ratings*

Voltage on any pin relative to VSS	-0.5V to 7.0V
Operating Temperature TA (Ambient)	
Commercial	0°C to +70°C
Industrial	-40°C to +85°C
Military	-55°C to +125°C
Storage Temperature	-65°C to +150°C
Power Dissipation	1 Watt
Output Current	20 mA
Junction Temperature, TJ	175°C

*Stress greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions greater than those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

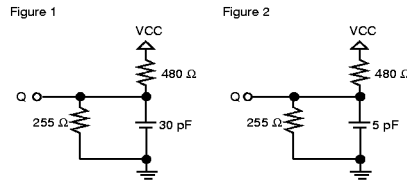
Recommended DC Operating Conditions

Parameter	Sym	Min	Typ	Max	Units
Supply Voltage	VCC	4.5	5.0	5.5	V
Supply Voltage	VSS	0	0	0	V
Input High Voltage	VIH	2.2	--	VCC+0.5	V
Input Low Voltage	VIL	-0.3	--	0.8	V

AC Test Conditions

Input Pulse Levels	VSS to 3.0V
Input Rise and Fall Times	5ns
Input and Output Timing Levels	1.5V
Output Load	Figure 1

(note: For TEHQZ, TGHQZ and TWLQZ, Figure 2)



DC Electrical Characteristics

Parameter	Sym	Conditions	Min	Typ*	Max	Units
Operating Power	ICC1	$\bar{W}, \bar{E} = VIL, I/O = 0mA, \text{Min Cycle}$	--		95	mA
Supply Current		$S = VIH$				
Standby (TTL) Power	ICC2	$\bar{E} \geq VIH \text{ \&/or } S \leq VIL,$	--		10	mA
Supply Current		$VIN \geq VIH \text{ \&/or } \leq VIL$				
Full Standby Power	ICC3	$\bar{E} \geq VCC-0.2V \text{ \&/or } S \leq VCC+0.2V$	C	--	1	mA
Supply Current		$VIN \geq VCC-0.2V \text{ \&/or } \leq 0.2V$	LP	--	1	mA
Input Leakage Current	ILI	$VIN = 0V \text{ to } VCC$	-5	--	5	μA
Output Leakage Current	ILO	$VIO = 0V \text{ to } VCC, \bar{E} \geq VIH \text{ \&/or } S \leq VIL$	-10	--	10	μA
Output High Voltage	VOH	$IOH = -1.0mA$	2.4	--	--	V
Output Low Voltage	VOL	$IOL = 2.1mA$	--	--	0.4	V

*Typical: TA=25°C, VCC=5.0V

Truth Table

\bar{G}	\bar{E}	\bar{S}	W	Mode	Output	Power
X	H	X	X	Standby	High Z	ICC2, ICC3
X	X	L	X	Standby	High Z	ICC2, ICC3
X	X	L	X	Output Deselect	High Z	ICC1
H	L	H	H	Output Deselect	High Z	ICC1
L	L	H	H	Read	DOUT	ICC1
X	L	H	L	Write	High Z	ICC1

Capacitance

(f=1.0MHz, VIN=VCC or VSS)

Parameter	Sym	Max	Unit
Address Lines	CI	12	pF
Input/Output Lines	CD/Q	14	pF

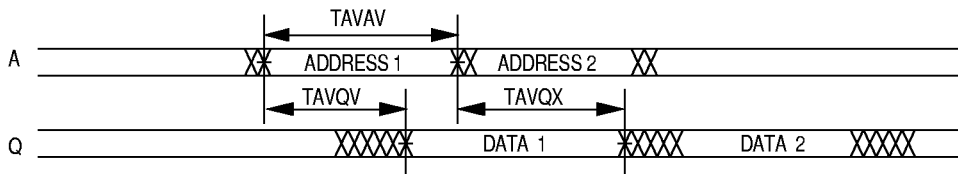
These parameters are sampled, not 100% tested.

AC Characteristics Read Cycle

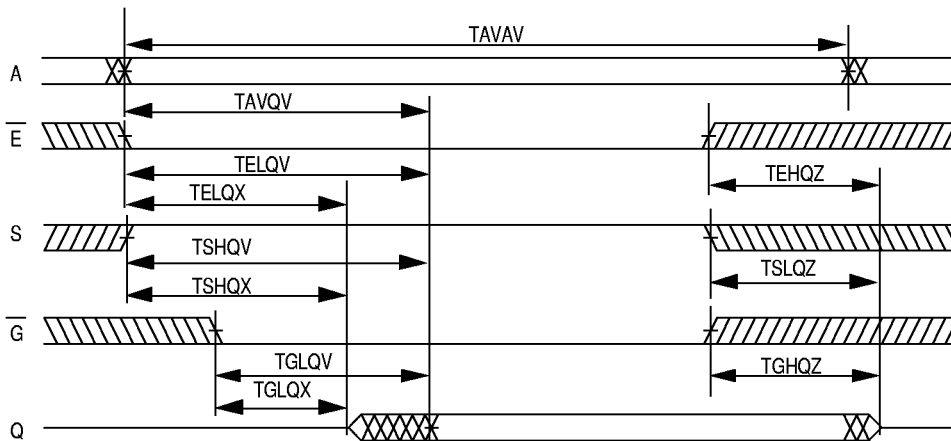
Parameter	Symbol		70ns		85ns		100ns		Units
	JEDEC	Alt.	Min	Max	Min	Max	Min	Max	
Read Cycle Time	TAVAV	TRC	70		85		100		ns
Address Access Time	TAVQV	TAA	70		85		100		ns
Chip Enable Access Time	TELQV	TACS	70		85		100		ns
	TSHQV	TACS	70		85		100		ns
Chip Enable to Output in Low Z (1)	TELQX	TCLZ	3		3		3		ns
	TSHQX	TCLZ	3		3		3		ns
Chip Disable to Output in High Z (1)	TEHQZ	TCHZ	0	30	0	35	0	40	ns
	TSLOZ	TCHZ	0	30	0	35	0	40	ns
Output Hold from Address Change	TAVQX	TOH	3		3		3		ns
Output Enable to Output Valid	TGLQV	TOE		35		45		50	ns
Output Enable to Output in Low Z (1)	TGLQX	TOLZ	0		0		0		ns
Output Disable to Output in High Z (1)	TGHQZ	TOHZ	0	30	0	35	0	35	ns

Note 1: Parameter guaranteed, but not tested.

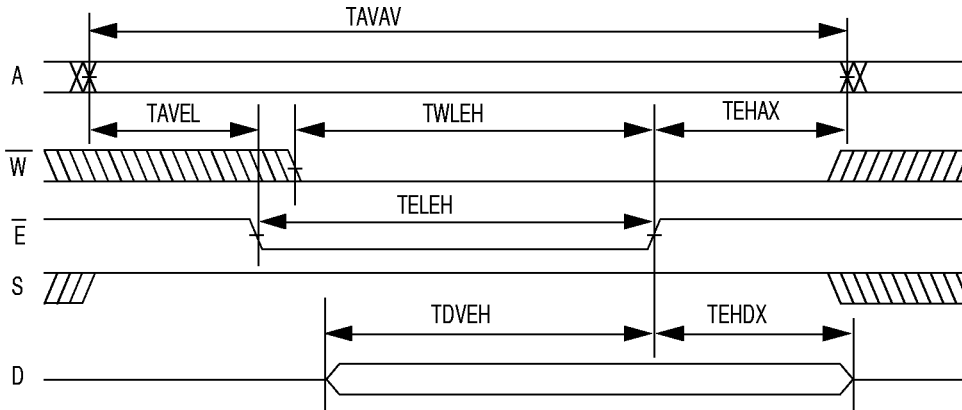
Read Cycle 1 - \overline{W} , S High; G, \overline{E} Controlled



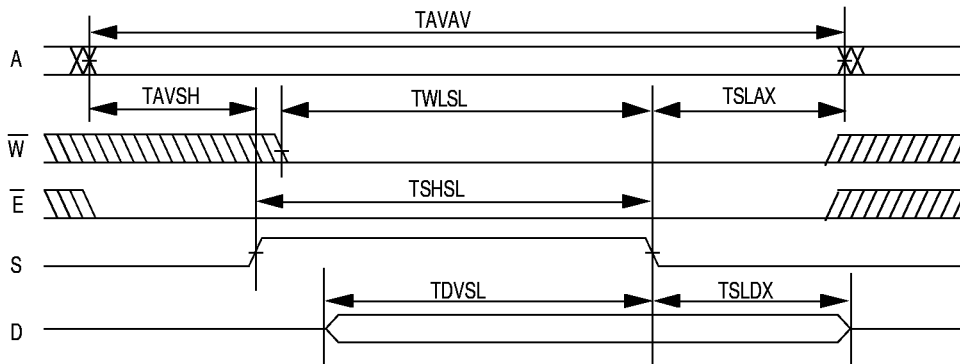
Read Cycle 2 - \overline{W} High



Write Cycle 2 - Early Write \bar{E} Controlled



Write Cycle 3 - Early Write S Controlled





Data Retention Characteristics

EDI88128LP & EDI88130LP Only

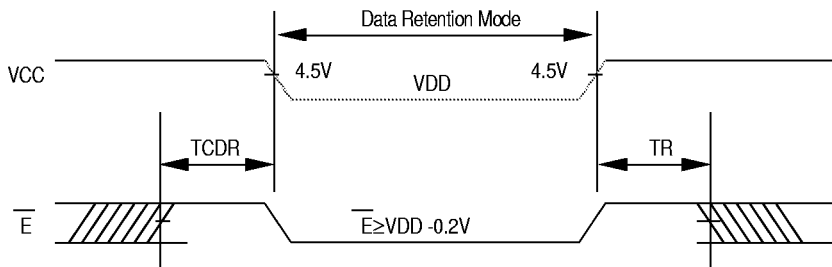
(TA = -55°C to +125°C)

Characteristic	Sym	Test Conditions	Min	Typ	Max	Unit
Data Retention Voltage	VDD	VDD = 2.0V	2	--	--	V
Data Retention Quiescent Current	ICCDR	$\bar{E} \geq VDD - 0.2V$	--	--	400	μA
Chip Disable to Data Retention Time(1)	TCDR	VIN \geq VDD - 0.2V	0	--	--	ns
Operation Recovery Time (1)	TR	or VIN \leq 0.2V	TAVAV*	--	--	ns

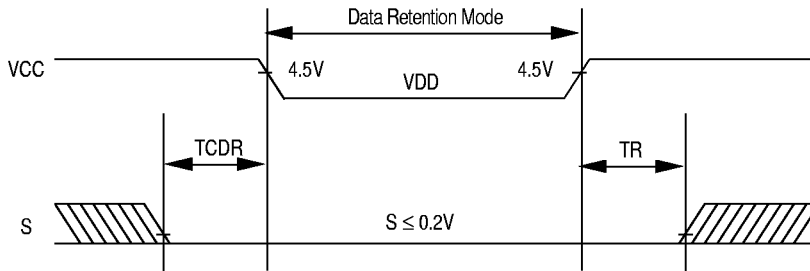
Note 1: Parameter guaranteed, but not tested.

*Read Cycle Time

Data Retention \bar{E} Controlled



Data Retention S Controlled



EDI88128C
128Kx8 Monolithic
Static Ram

Ordering Information

Single Chip Enable, Military

	Speed	Package
Standard Power	ns	No.
EDI88128C70CB	70	9
EDI88128C85CB	85	9
EDI88128C100CB	100	9
EDI88128C70NB	70	140
EDI88128C85NB	85	140
EDI88128C100NB	100	140
EDI88128C70ZB	70	100
EDI88128C85ZB	85	100
EDI88128C100ZB	100	100

	Speed	Package
Low Power	ns	No.
EDI88128LP70CB	70	9
EDI88128LP85CB	85	9
EDI88128LP100CB	100	9
EDI88128LP70NB	70	140
EDI88128LP85NB	85	140
EDI88128LP100NB	100	140
EDI88128LP70ZB	70	100
EDI88128LP85ZB	85	100
EDI88128LP100ZB	100	100

Dual Chip Enable, Military

	Speed	Package
Standard Power	ns	No.
EDI88130C70CB	70	9
EDI88130C85CB	85	9
EDI88130C100CB	100	9
EDI88130C70NB	70	140
EDI88130C85NB	85	140
EDI88130C100NB	100	140
EDI88130C70ZB	70	100
EDI88130C85ZB	85	100
EDI88130C100ZB	100	100

	Speed	Package
Low Power	ns	No.
EDI88130LP70CB	70	9
EDI88130LP85CB	85	9
EDI88130LP100CB	100	9
EDI88130LP70NB	70	140
EDI88130LP85NB	85	140
EDI88130LP100NB	100	140
EDI88130LP70ZB	70	100
EDI88130LP85ZB	85	100
EDI88130LP100ZB	100	100

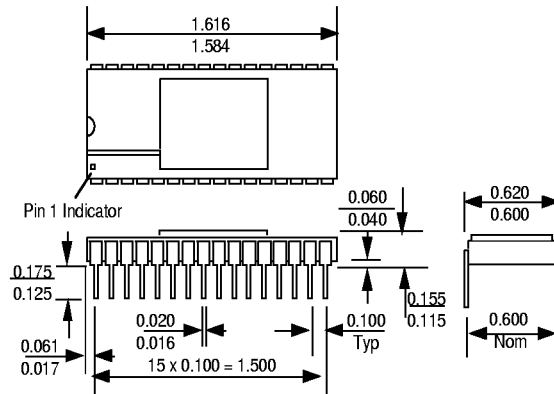
For Commercial, Industrial or Military grade product use C, I or M respectively, to replace B in the suffix of the part number, e.g. EDI88128C70CB becomes EDI88128C70CC (Commercial temp. range), EDI88128C70CI (Industrial temp. range), or EDI88128C70CM (Military temp range).



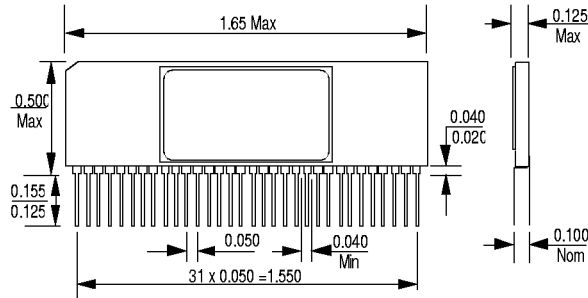


Package Description

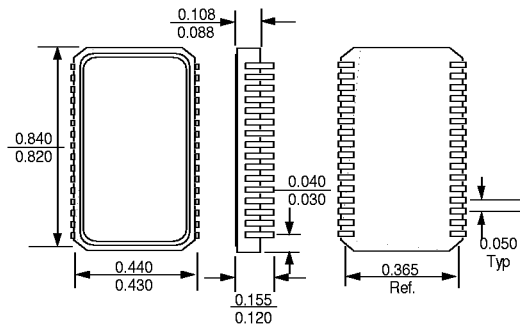
Package No. 9
32 Pin Ceramic Sidebrazed
Dual-in-line Package
600 mils wide



Package No. 100
32 pin Ceramic Zip



Package No. 140
32 lead CSOJ,
Ceramic J-Leaded
Chip Carrier



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